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Vishay/Siliconix SI4621DY-T1-E3

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P-Channel 20-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY							
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)				
- 20	0.054 at V _{GS} = - 10 V	6.2	4.5 nC				
	$0.094 \text{ at V}_{GS} = -4.5 \text{ V}$	4.7	4.5 110				

SCHOTTKY PRODUCT SUMMARY					
V _{KA} (V)	V _f (V) Diode Forward Voltage	I _F (A) ^a			
20	0.45 at 1 A	2			

FEATURES

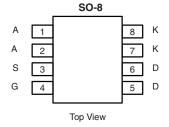
- Halogen-free According to IEC 61249-2-21 Definition
- LITTLE FOOT[®] Plus Schottky
- Compliant to RoHS Directive 2002/95/EC



ROHS COMPLIANT HALOGEN FREE

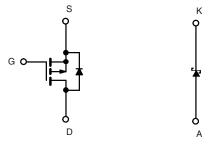
APPLICATIONS

- Portable Devices
 - Ideal for Boost Circuits
 - Ideal for Buck Circuits



Ordering Information: Si4621DY-T1-E3 (Lead (Pb)-free)

Si4621DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

Parameter		Symbol	Limit	Unit
Drain-Source Voltage (MOSFET)		V_{DS}	- 20	
Reverse Voltage (Schottky)		V _{KA}	20	V
Gate-Source Voltage (MOSFET)		V_{GS}	± 20	
	T _C = 25 °C		- 6.2	
Continuous Drain Current (T _{.I} = 150 °C) (MOSFET)	T _C = 70 °C	I _D	- 5 ^a	
Continuous Brain Current (1) = 150 C) (MCCr E1)	T _A = 25 °C	טי	- 5 ^{b, c}	
	T _A = 70 °C		- 4 ^{b, c}	
Pulsed Drain Current (MOSFET)		I _{DM}	- 25	А
Continuous Source-Drain Diode Current	T _C = 25 °C	l-	- 2.6	
(MOSFET Diode Conduction)	T _A = 25 °C	l _S	1.7 ^{b, c}	
Average Forward Current (Schottky)		I _F	2 ^b	
Pulsed Forward Current (Schottky)	I _{FM}	5		
	T _C = 25 °C		3.1	
Maximum Power Dissipation (MOSFET)	T _C = 70 °C		2	
Maximum Tower Dissipation (MOSI ET)	T _A = 25 °C		2 ^{b, c}	
	T _A = 70 °C	P_{D}	1.3 ^{b, c}	W
	T _C = 25 °C	, р	2.7	• • • • • • • • • • • • • • • • • • • •
Maximum Power Dissipation (Schottky)	T _C = 70 °C		1.7	
Maximum Fower Dissipation (Constity)	T _A = 25 °C		1.6 ^{b, c}	
	T _A = 70 °C		1 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

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THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient (MOSFET) ^{b, f}	R _{thJA}	55	62.5				
Maximum Junction-to-Foot (Drain) (MOSFET)	R _{thJF}	33	40	°C/W			
Maximum Junction-to-Ambient (Schottky) ^{b, g}	R _{thJA}	63	78	C/VV			
Maximum Junction-to-Foot (Drain) (Schottky)	R_{thJF}	39	47				

Notes:

- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- f. Maximum under Steady State conditions is 110 °C/W.
- g. Maximum under Steady State conditions is 115 °C/W.

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 16		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			3.6		mv/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Cuwant	1	V _{DS} = - 20 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le 5 \text{ V}, V_{GS} = -10 \text{ V}$	- 25			Α	
	_	V _{GS} = - 10 V, I _D = - 5 A		0.042	0.054	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 1.1 A		0.073	0.094		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 5 A		10		S	
Dynamic ^b							
Input Capacitance	C _{iss}			450			
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		160		pF	
Reverse Transfer Capacitance	C _{rss}			105		1	
		$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -6.2 \text{ A}$		8.7	13		
Total Gate Charge	Qg			4.5	6.8		
Gate-Source Charge	Q_{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -6.2 \text{ A}$		1.7		nC	
Gate-Drain Charge	Q_{gd}			1.8			
Gate Resistance	R_{g}	f = 1 MHz		9		Ω	
Turn-On Delay Time	t _{d(on)}			15	25		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_{L} = 2.5 \Omega$		60	90	1	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 4 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		22	35	1	
Fall Time	ì _f	Ī		15	25]	
Turn-On Delay Time	t _{d(on)}			5	10	ns	
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_{L} = 2.5 \Omega$		60	90	1	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -4 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		20	30		
Fall Time	t _f	- g		7	15	1	

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions		Тур.	Max.	Unit	
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 6.2	۸	
Pulse Diode Forward Current	I _{SM}				- 25	Α	
Body Diode Voltage	V _{SD}	I _S = - 1.7 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			21	40	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$I_F = -1.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25$		10	20	nC	
Reverse Recovery Fall Time	t _a	°C		7		no	
Reverse Recovery Rise Time	t _b			16		ns	

Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

SCHOTTKY SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Forward Voltage Drop	V _F	I _F = 1 A		0.41	0.45	V	
		I _F = 1 A, T _J = 125 °C		0.36	0.41		
	I _{rm}	V _r = 20 V		0.02	0.20	mA	
Maximum Reverse Leakage Current		V _r = 20 V, T _J = 85 °C		0.7	7		
		V _r = 20 V, T _J = 125 °C		5	50		
Junction Capacitance	C _T	V _r = 10 V		60		pF	

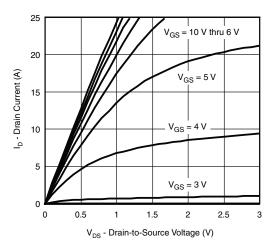
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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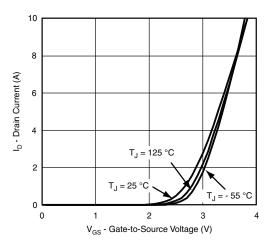
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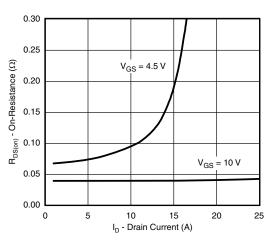
MOSFET TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



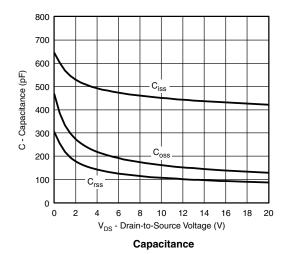
Output Characteristics

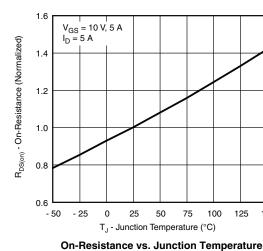


Transfer Characteristics

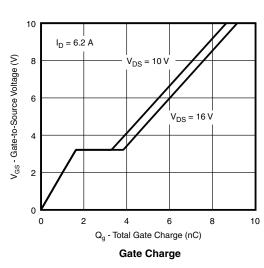


On-Resistance vs. Drain Current and Gate Voltage









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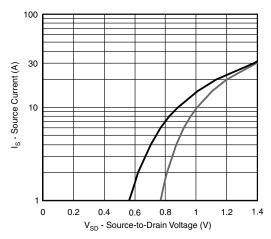
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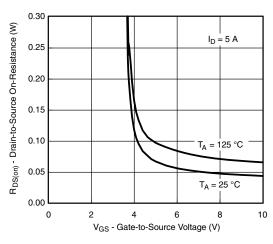


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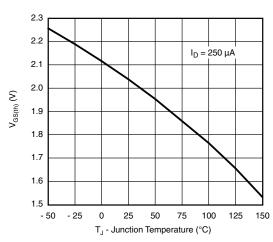
MOSFET TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



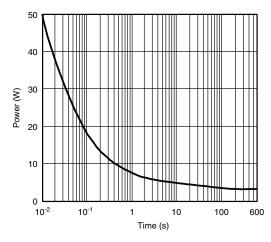
Source-Drain Diode Forward Voltage



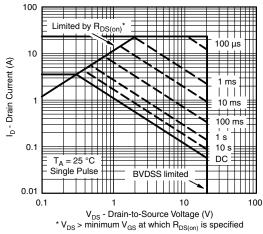
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Case

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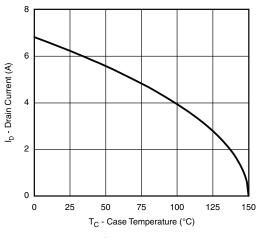
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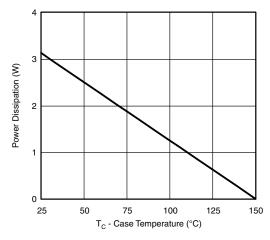
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MOSFET TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)





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Current Derating*

Power Derating

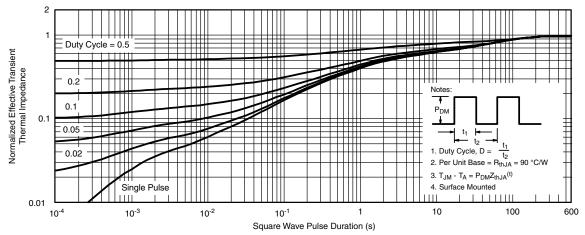
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



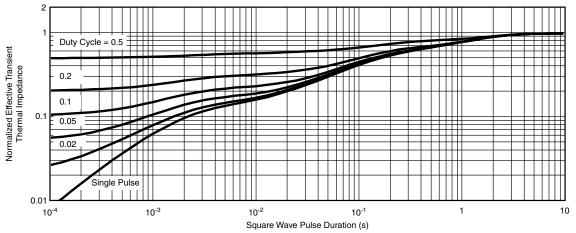


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MOSFET TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

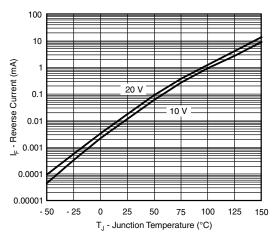
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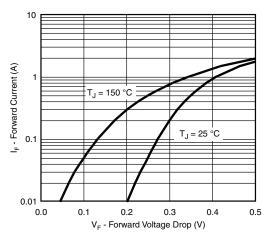


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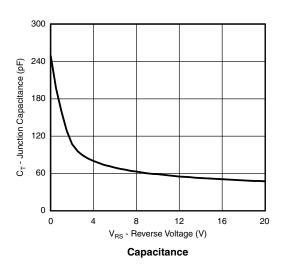
SCHOTTKY TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)





Reverse Current vs. Junction Temperature

Forward Voltage Drop



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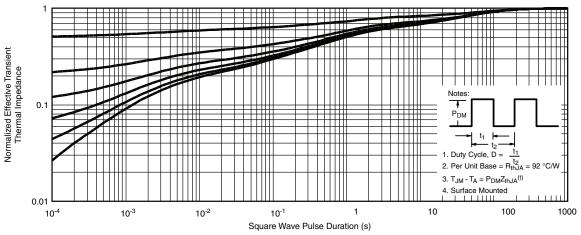
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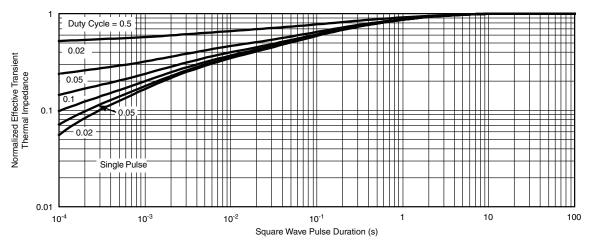
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Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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